ECP2459



4.5-60V 0.5A 480KHz Step-down converter in a SOT23-6

Preliminary v01 01/2020

Description

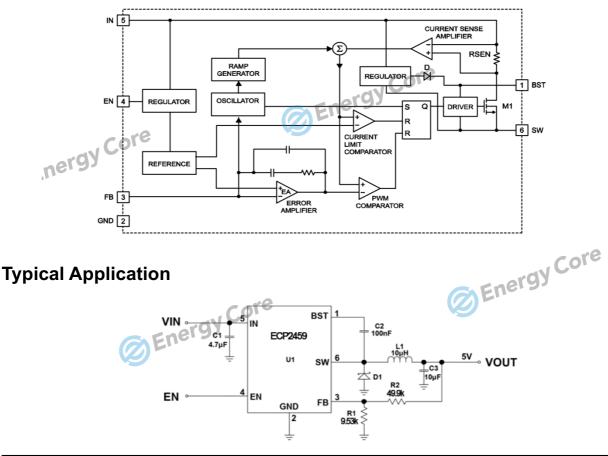
The ECP2459 is a monolithic,step-down, switch-mode converter with a built-in power MOSFET. It achieves a 0.5A peak-output current over a wide input supply range with excellent load and line regulation. Currentmode operation provides a fast transient response and eases loop stabilization. Fault condition protections include cycle-by-cycle current limiting and thermal shutdown. The ECP2459 requires a minimal number of readily available, external components and is available in a space saving SOT23-6 package.

Feature

- Input voltage range : 4.5V~60V
- 0.5A peak output current
- 1Ω Internal power MOSFET
- Fixed 480KHz frequency
- Up to 90% efficiency
- 1µA shutdown mode
- Package Type : SOT23-6

Application

- Power meters
- Distributed power systems, Energy
- Industrial power systems
- Battery chargers
- Pre-regulator for linear regulators



Functional Block Diagram

Absolute Maximum Ratings

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage	V _{IN}		-0.3		62	V
SW Voltage	V _{sw}		-0.3		62	V
EN Voltage	V _{EN}		-0.3		44	V
FB Voltage	V _{FB}		-0.3	v Cor	6	V
Junction Temperature	TJ	Ø	ner9	,	+150	°C
ardy Core	-	9				

Electrical Characteristics Vin=12V, Vout=5V,TA=25°C(unless otherwise noted)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input Voltage Range	VIN		4.5		60	V
Feedback Voltage	VFB	4V~30V	0.792	0.812	0.832	V
Feedback Current	IFB	VEN=0V		0.1	1.0	9΄ μΑ
Switch-On Resistance	RDS(ON)	VBST-VSW=5V		1.0	F	Ω
Switch Leakage	ISW_LKG	VEN=0V, VSW=0V			1.0	μΑ
Current Limit	ILIM		1.0	1.25	1.5	А
Oscillator Frequency	fSW	VFB=0.6V	380	480	580	kHz
Foldback Frequency	fSW_F	VFB=0V		100		kHz
Minimum ON-Time(1)	τΟΝ			100		ns
Under-Voltage Lockout Threshold, Rising	VUVLO_R	av Core	2.9	3.3	3.7	V
Under-Voltage Lockout Threshold, Falling		Energy Core	2.65	3.05	3.45	V
EN Threshold, Rising	VEN_R			1.35		V
EN Threshold, Falling	VEN_F			1.17		V
	IEN	VEN=2V		3.1		
EN Input Current		VEN=0V		0.1	Cor	μA (2)
Supply Current(Shutdown)	IS	VEN=0V		0.1 9	y 1.0	μΑ
Supply Current(Quiescent)	COLO	VEN=2V,VFB=1V	Ø	0.73	0.85	mA
Supply Current(Quiescent) Thermal Shutdown(1) Energy Thermal Shutdown Hysteresis(1)	TSD			165		°C
Thermal Shutdown Hysteresis(1)	TSD_HYS			20		°C

Notes:

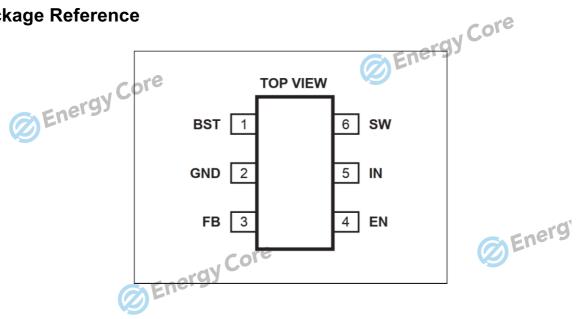
1) Derived from bench characterization. Not tested in production.



Ordering Information

Part Number*	Package	Top Marking
ECP2459	SOT23-6	59XXX

Package Reference



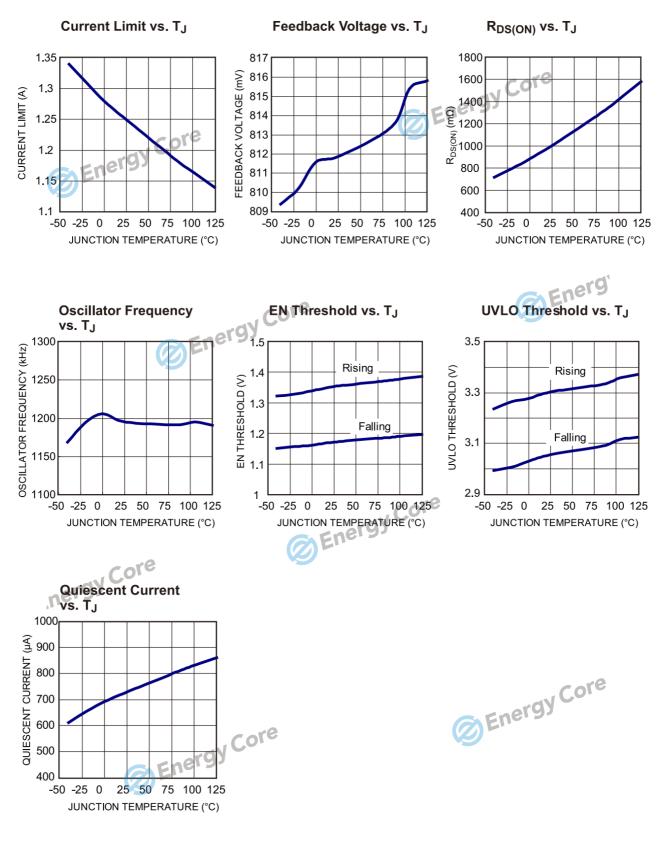
Pin Functions

Pin#	Name	Description
1	BST	Bootstrap pin for top switch. A 0.1uF or larger capacitor should be connected between this pin and the SW pin to supply current to the top switch and top switch driver.
2	GND	Ground pin.
3	еғву	Output feedback pin. Input to the error amplifier.Set the output voltage.When the load is short-circuited, FB voltage is lower than 250mV, the return circuit will reduce the oscillation frequency to ensure reliable current limiting protection.
4	EN	Enable input, pull the pin voltage below the specified threshold to close the chip.Pull above the specified threshold to make the chip work.Connect 100K resistor with IN to start automatically .
5	IN	Input voltage pin. VIN supplies power to the IC. Connect a 4.5V to 60V supply to VIN and bypass VIN to GND with a suitably large capacitor to eliminate noise on the input to the IC
6	SW	SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load.



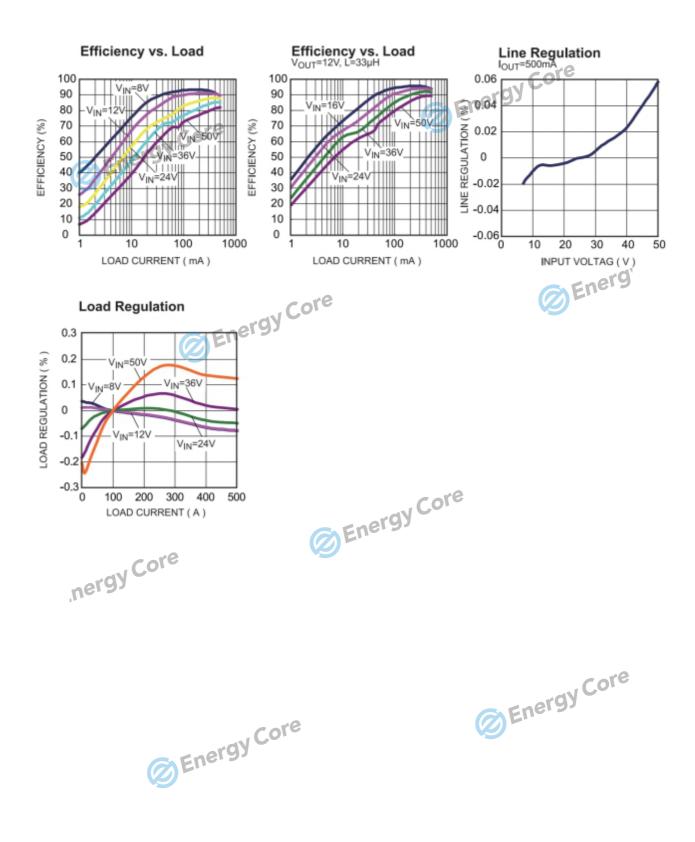
Typical Characteristics

VIN=12V, unless otherwise noted.



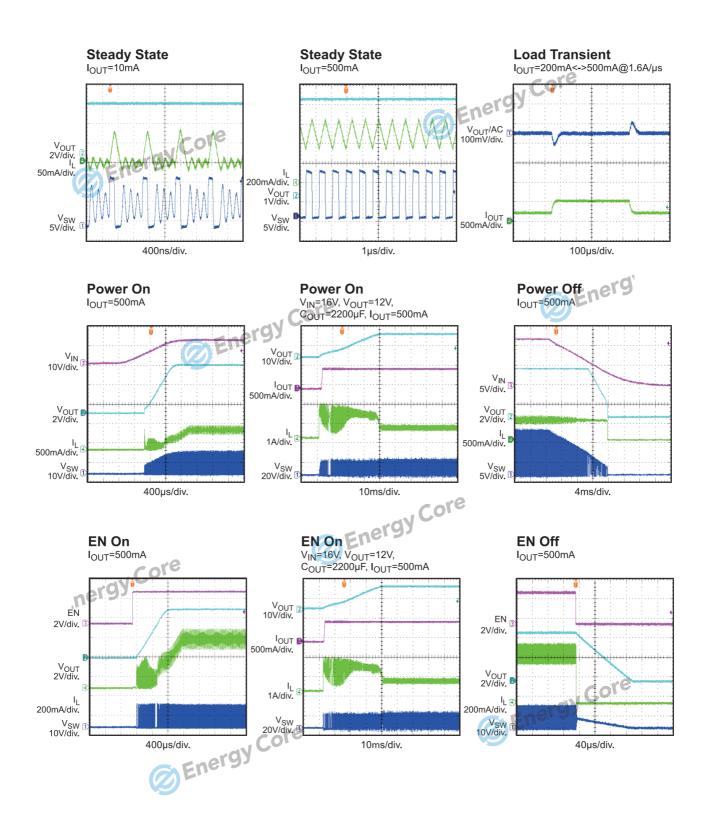
Typical Performance Characteristics (continued)

VIN=12V, VOUT=5V, L=10µH, TA=25°C, unless otherwise noted.



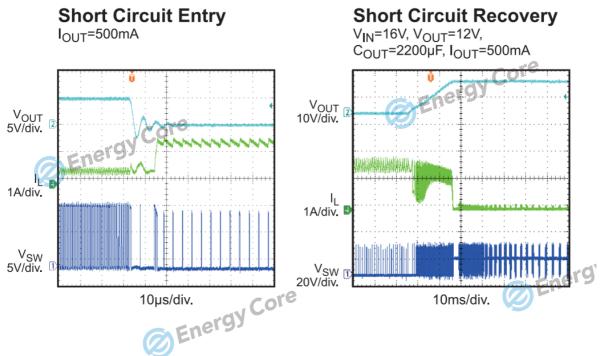
Typical Performance Characteristics (continued)

VIN=12V, VOUT=5V, L=10µH, TA=25°C, unless otherwise noted.



Typical Performance Characteristics (continued)

VIN=12V, VOUT=5V, L=10µH, TA=25°C, unless otherwise noted.



Application Information

Setting Output Voltage

The external resistor divider sets the output voltage (see the Typical Application schematic). Table 1 lists resistors for common output voltages. The feedback resistor (R2) also sets the feedback loop bandwidth with the internal compensation network (see Figure 1). R1 is: Col

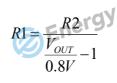




Table 1: Resistor Selection for Common Output Voltages

VOUT (V)	R1 (kΩ)	R2 (kΩ)
5	9.53(1%)	49.9(1%)
3.3	core 16.2(1%)	49.9(1%)
2.5 Energ	23.7(1%)	49.9(1%)
1.8	64.9(1%)	80.6(1%)

Selecting the Inductor

The recommended inductor values are shown in the Application Diagram. It is important to guarantee the inductor core does not saturate during any foreseeable operational situation. The inductor should be rated to handle the peak load current plus the ripple current: Care should be taken when reviewing the different saturation current ratings that are specified by different manufacturers. Saturation current ratings are typically specified at 25°C, so ratings at maximum ambient temperature of the application should be requested from the manufacturer.

hergy
$$L = \frac{V_{OUT} * (V_{IN} - V_{OUT})}{V_{IN} * \Delta I_L * f_{SW}}$$

Where ΔIL is the inductor ripple current. Choose the inductor ripple current to be 30% of the maximum load current. The maximum inductor peak current is:

$$\mathbf{I}_{\mathrm{L}(\mathrm{MAX})} = \mathbf{I}_{\mathrm{LOAD}} + \frac{\Delta \mathbf{I}_{\mathrm{L}}}{2}$$

Under light-load conditions (below 100mA), use a larger inductance to improve efficiency.

Selecting the Input Capacitor

The input capacitor reduces the surge current drawn from the input supply and the switching noise from the device. The input capacitor impedance at the switching frequency should be less than the input source impedance to prevent high-frequency-switching current from passing through the input. Use ceramic capacitors with X5R or X7R dielectrics for their low ESRs and small temperature coefficients. For most applications, a 4.7µF capacitor will sufficient.

Selecting the Output Capacitor

The output capacitor keeps the output voltage ripple small and ensures feedback loop stability. The output capacitor impedance should be low at the switching frequency. Use ceramic capacitors with X5R or X7R dielectrics for their low ESR characteristics. For most applications, a 22µF ceramic capacitor will sufficient.

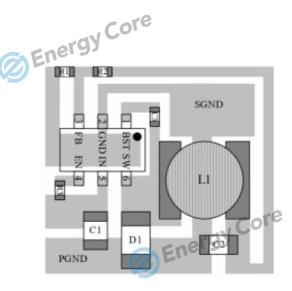
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PCB Layout Guide

PCB layout is very important to stability. Please follow these guidelines and use Figure 1 as reference.

- Keep the path of switching current short and minimize the loop area formed by the input capacitor, high-side MOSFET, and Schottky diode.
- Keep the connection from the power ground →Schottky diode-→SW pin as short and wide as possible.
- 3) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- 4) Route SW away from sensitive analog areas such as FB.
- 5) Connect IN, SW, and especially GND to large copper areas to cool the chip for improved thermal performance and longterm reliability. For single layer PCBs, avoid soldering the exposed pad.



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Figure 1:PCB Layout

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Typical Application Circuit

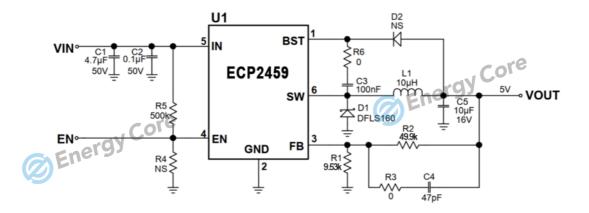
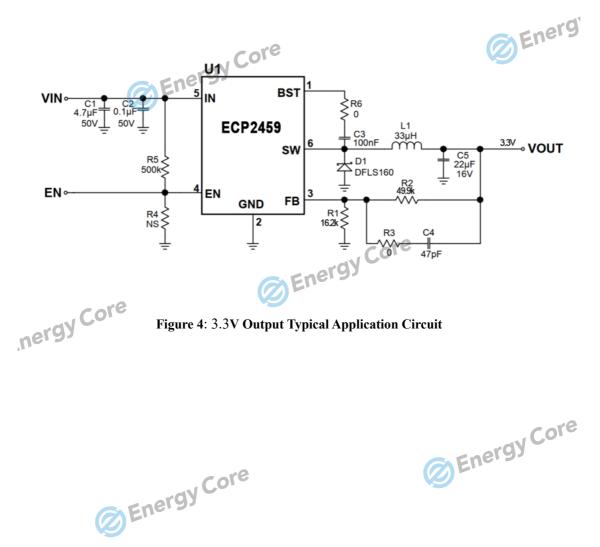


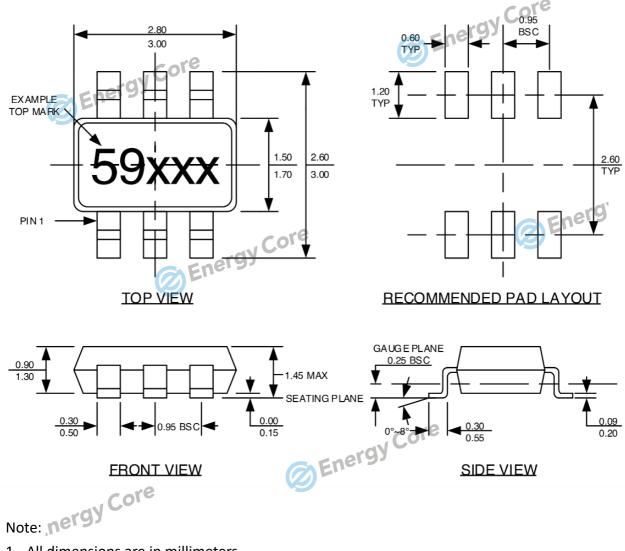
Figure 3: 5V Output Typical Application Circuit:





Package Information

SOT23-6



- 1. All dimensions are in millimeters.
- 2. Package length does not include mold flash, protrusion or gate burr.
- 3. Package width does not include flash or protrusion.
- 4. Lead coplanarity (bottom of leads after forming) shall be 0.10 millimeters max.
 5. Pin 1 is lower left pin when reading top mark from left to right.

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